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	MATION DI		ATTY. DOCKET NO. SUN-P9323-SPL		APPLICATION NO. 10/637,166			
	CITATIO	APPLICANT Marc Tremblay, et al.						
PTO-1449				FILING DATE August 8, 2003		GROUP ART UNIT 2183		
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		ENTS (Including Aut						
199	Publication: "Speculative Synchronization: Applying Thread-Level Speculation to Explicitly Parallel Applications" by Jose F. Martinez and Josep Torrellas, Dept. of Computer Science, University of Illinois at Urbana-Champaign, Urbana, IL 61801 USA, http://iacoma.cs.uiuc.edu , XP-002285169, published in ASPLOS X, 10-2002, Pgs. 18-29.							
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. //	Publication: "Transactional Memory: Architectural Support for Lock-Free Data Structures" by Maurice Herlihy, Digital Equip. Corp. Cambridge Research Laboratory, Cambridge, MA 02139, herlihy@crl.dec.com and J. Eliot B. Moss, Dept. of Computer Science, University of Massachusetts, Amherst, MA 01003, moss@cs.umass.edu , XP-000380375, published in Computer Architecture News, May 21, 1993, Pgs. 289-300							
	Publication: "Enhancing Software Reliability with Speculative Threads" by Jeffrey Oplinger and Monica S. Lam, Computer Systems Laboratory, Stanford University, jeffop@stanford.edu, XP-002285168 published in ASPLOS X, 10-2002, Pgs. 184-196							
EXAMINER	1/		DATE CONSIDE	RED	11/0	6		

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.